

SETTLEMENT OF CLAIMS

Convention signed at Lima December 4, 1868

Senate advice and consent to ratification April 15, 1869

Ratified by the President of the United States May 3, 1869

Ratifications exchanged at Lima June 4, 1869

Entered into force June 4, 1869

Proclaimed by the President of the United States July 6, 1869

*Terminated February 26, 1870*¹

16 Stat. 751; Treaty Series 281

Whereas claims may have, at various times since the signature of the decisions of the mixed commission which met in Lima in July, 1863, been made on the government of the United States of America, by citizens of Peru, and have been made by citizens of the United States of America on the government of Peru, and whereas some of such claims are still pending, the President of the United States of America and the President of Peru, being of opinion that a speedy and equitable settlement of all such claims will contribute much to the maintenance of the friendly feelings which subsist between the two countries, have resolved to make arrangements for that purpose by means of a convention, and have named as their plenipotentiaries to confer and agree thereupon, that is to say:

The President of the United States names Alvin P. Hovey, envoy extraordinary and minister plenipotentiary of the United States of America near the government of Peru, and the President of Peru names his excellency Doctor Don José Antonio Barrenechea, minister of foreign affairs of Peru, who, after having communicated to each other their respective full powers, found in good and true form, have agreed as follows:

ARTICLE I

The high contracting parties agree that all claims on the part of corporations, companies, or private individuals, citizens of the United States, upon the government of Peru, and all claims on the part of corporations, companies, or private individuals, citizens of Peru, upon the government of the United States, which may have been presented to either government for its

¹ For final report of Commission, see Moore, *International Arbitrations*, vol. II, p. 1645.